ABSTRACT OF THESIS

VERILOG DESIGN AND FPGA PROTOTYPE OF A NANOCONTROLLER SYSTEM

Many new fabrication technologies, from nanotechnology and MEMS to printed organic semiconductors, center on constructing arrays of large numbers of sensors, actuators, or other devices on a single substrate. The utility of such an array could be greatly enhanced if each device could be managed by a programmable controller and all of these controllers could coordinate their actions as a massively-parallel computer. *Kentucky Architecture nanocontroller* array with very low per controller circuit complexity can provide efficient control of nanotechnology devices.

This thesis provides a detailed description of the control hierarchy of a digital system needed to build "nanocontrollers" suitable for controlling millions of devices on a single chip. A Verilog design and FPGA prototype of a nanocontroller system is provided to meet the constraints associated with a massively-parallel programmable controller system.

KEYWORDS: Nanocontroller, Control hierarchy, *KITE*, Verilog Design, Hierarchical clock.

Akshay Vummannagari 5/3/2010

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By Akshay Vummannagari

> Henry G. Dietz, Ph.D. (Director of Thesis)

Ingrid St. Omer, Ph.D (Co-Advisor)

Stephen D. Gedney, Ph.D. (Director of Graduate Studies)

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By

Akshay Vummannagari

The Graduate School University of Kentucky 2010

VERILOG DESIGN AND FPGA PROTOTYPE OF A NANOCONTROLLER SYSTEM

THESIS

A thesis submitted in partial fulfillment of the requirements of the Degree of Master of Science in Electrical Engineering in the College of Engineering at the University of Kentucky

By

Akshay Vummannagari Lexington, Kentucky Director: Dr. Henry G. Dietz, Department of Electrical and Computer Engineering Lexington, Kentucky 2010

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Acknowledgements

I would like to thank my mentor and Thesis Chair Dr. Hank Dietz for igniting an interest in computer architecture and nanocontrollers. His timely guidance and encouragement at every stage of the thesis process, allowed the successful completion of this project. Next, I would like to thank my Co-Advisor Dr. Ingrid St. Omer for her insights and guidance throughout my masters program. Further, I would like to thank Dr. Robert Heath for providing Xilinx software and prototyping board without which the project would have been incomplete.

I would also like to thank my friends at University of Kentucky and KAOS group members for their valuable inputs. Above all, I would like to thank my parents and family members for their never ending support and motivation.

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Chapter 1

1.1 Introduction

Developments in nanotechnology have made it possible to assemble a large number of nanostructures such as sensors and actuators to be fabricated on a single chip. Conventionally, these sensors and actuators are controlled by an off-chip microcontroller or microprocessor. With an ever increasing number of sensors per chip it is not practical to route thousands of signals off-chip to an external controller. An I/O bottleneck restricts the rate at which data can be transferred in and out of the nanostructure array. Integrating the sensors and processors on a single chip can solve the I/O bottleneck. The modern day microcontroller/microprocessor designs are not small enough to be paired with each of the thousands of sensing devices on-chip.

The nanocontrollers aim to integrate sensors, actuators with processing elements on the same chip using existing fabrication techniques currently employed by companies like Intel in producing their high-end microprocessors. A single chip "nanocontroller array" with a comparable die size could implement a massively parallel programmable control system with several million nanocontrollers. These independently programmable nanocontrollers have their own local input and output paths potentially providing millions of digital and analog I/O lines. The majority of these I/O lines will not be headed off chip in the conventional way, but would be connected to the millions of tiny devices that require intelligent control.

The sensors and processing elements are controlled by a Control unit and an instruction sequencer. The control system acts as an interface between the host (typically a desktop PC) and the sensor-processor array. The number of sensors per chip is limited by the number of signals that can be sent off-chip. To observe the advantages of a single chip system the controller has to be on chip occupying minimum circuitry.

1.2 Contribution of Thesis

Earlier work on nanocontrollers focused on the minimization of circuit size, KITE architecture, compiler technology and BitC programming language. A detailed

Processing Element implementation and instruction set architecture had been provided. Current work provides detailed architectural features of digital control hierarchy required to control a nanocontroller system along with an interface mechanism to boot the nanocontrollers from a host system.

A complete Verilog description and FPGA (Field Programmable Gate Array) prototype of a nanocontroller system from the processing element and its driving hardware, to the host controlling system has been built. Interconnection network, initialization and clock hierarchy features have been tested. Timing analysis, device utilization and scalability of nanocontrollers have been observed.

1.3 Organization of Thesis

Chapter 2 provides background for nanocontrollers. The constraints on nanocontroller architecture along with possible applications of a nanocontroller system are described. For a clear understanding of the nanocontroller system, background concepts of Meta-State conversion, Common Sub-expression Induction, *KITE* architecture and *BitC* compiler have been described.

Previous work on nanocontrollers focused on processing element implementation with few suggestions about the control hierarchy. Chapter 3 gives a detailed description of the control hierarchy along with details of interconnection network, clock hierarchy and initialization process.

Chapter 4 describes the HDL implementation and FPGA prototype of nanocontroller architecture. The various modules and their HDL implementation have been described. Simulations for understanding of initialization and control flow process are provided.

Chapter 5 compares the performance of nanocontroller implementation with other processor cores. Scalability and timing analysis of nanocontrollers is discussed. Chapter 6 presents the conclusion and future work.

Chapter 2

2.1 Motivation and Background

Nanocontrollers integrate processing elements and sensing units in a sensor array, making ordinary nanofabricated sensors intelligent. Programmable control is everywhere except in devices that are too small to integrate a microcontroller/microprocessor. Sensors are analog in nature and the processing is digital. Integrating the two is a difficult task. The nanocontrollers have an order of magnitude less circuitry, enabling controllers to fit alongside the devices they control.



Figure 2.1: Block diagram of nanocontrollers

Low level processing tasks; for example filtering, edge detection and feature extraction in an image processing application of the nanocontrollers, are computationally intensive but are inherently parallel in nature. Nanocontrollers processing element per sensor architecture can provide real time processing speeds for such tasks. The processing takes place adjacent to the pixels from which it originated eliminating long distance data transfers and the I/O bottleneck between the sensor and the processing elements reducing power dissipation, size and cost of the system.

It is well known that a carbon nanotube (CNT), or clump of CNTs, can be used as a chemical sensor that distinguishes compounds by the way the electrical resistance changes over time. In order to build a sensor array, a wafer is first created that contains a pattern of exposed contacts. Low temperature nanofabrication methods, such as inkjet printing of a suspension of CNTs, are used to deposit clumps of nanotubes over the metal contacts.

The number of sensors per chip is limited primarily by the difficulty of sending huge numbers of sensitive analog signals off-chip for precise measurement of resistance. Suppose that an array of millions of the proposed nanocontrollers could be constructed on the die using conventional VLSI fabrication technology. Each nanocontroller would have a small number of I/O lines connected to metal pads on the top layer of the die. Each nanocontroller directly measuring the resistance of the sensor above it, the problem of routing sensitive analog signals off-chip is eliminated. Further, by working together as a massively-parallel computer, the nanocontrollers can reduce the data to a smaller, higher level, summary. Rather than sending raw sensor data to be processed elsewhere, it could be processed by the massively parallel on-chip nanocontroller system so that the chip would directly output the parts-per-million (PPM) concentration of each compound sensed as digital data.

The nanocontrollers are not only restricted to the above application but can be used for other sensor applications such as:

Imaging sensors used in digital cameras loose image quality due to applying the same gain and integration time settings to all pixels. With a nanocontroller under each pixel, each pixel can be adjusted independently and calibrated corrections for defects applied, yielding much greater dynamic range and lower noise. *Smart Pixels*, Integration of photo detector arrays and nanocontrollers on a single chip with real time processing capability can reduce a complex image into a manageable stream of signals.hereby reducing the number of signals sent off chip.

DLP (*Digital Light Processor*) video projectors use DMD (Digital Micro-mirror Device) technology. DMD chip is made of several hundred thousand mirrors arranged in a rectangular array. Each mirror corresponds to a pixel in the image to be displayed. Each individual mirror can be rotated 10-12° to an on/off state. Light from the projector bulb is reflected into the lens making the pixel appear bright in the on-state and dark in the off-state. Intermediate shades are obtained by controlling the on/off times using PWM (Pulse Width Modulation). With a nanocontroller device located on the same chip to control the modulation, DMD chips can yield smoother shades. Nanocontrollers would be appropriate as embedded controllers for Micro-ElectroMechanical Devices (MEMS) and other larger devices.

2.2 Constraints on Nanocontroller Architecture

The idea of nanocontrollers embedded with nanofabricated devices cannot be implemented using conventional microcontroller architectures and compilation technology as conventional microcontrollers occupy lot of circuitry. A new set of architectural and compilation technologies have to be developed that satisfy the basic requirements for such a system. There are six primary requirements, outlined in the following subsections.

2.2.1 Minimal Circuit Size

The circuit complexity per nanocontroller must be small enough to be comparable in physical size to sensors, actuators, and other devices implemented using nanotechnology. Even the simplest microcontrollers generally require *thousands of transistors*; the goal is to reduce that number to no more than a few *hundred transistors*. This is far less than the estimated 10,000 transistors per SIMD processing element proposed for SOSA (Self-Organizing nano-scale SIMD Architecture) [1]. This extremely low complexity is the primary characteristic of a nanocontroller. Due to its low complexity nanocontrollers built with current CMOS technology can be physically small enough to control devices fabricated by very aggressive nanotechnology processes.

2.2.2 Predictable Real-Time Behavior

From a programmer's point of view, a nanocontroller must have predictable realtime execution timing characteristics. In order to monitor or control the real-time behavior of a device, it will often be necessary for the nanocontroller to perform particular operations at precise times relative to other operations. Although some nanotechnology devices can tolerate very slow controller time bases, the required timing precision varies greatly depending on the type of device with which the nanocontroller must interact. The small physical scale of some devices results in relatively small time constants. As an initial goal, a nanocontroller should be able to handle real-time constraints with accuracies no worse than a microsecond.

2.2.3 Localized Input/Output

Each nanocontroller must be able to perform appropriate digital and/or analog input/output (I/O) operations to interact with the sensing unit it is associated. Digital I/O may be as simple as having some memory cells or registers be input/output devices.

Analog I/O is substantially more complex. Many nanotechnology devices have inherently analog interfaces, and the space required for separate Analog-to-Digital Converter (ADC) or Digital-to-Analog Converter (DAC) units would be too great. Thus, an analog input would most likely be implemented by measuring the time taken for a digital threshold voltage to be crossed in charging a capacitor. An analog output can be accomplished by a similar process, essentially using Pulse-Width Modulation (PWM) software to drive a simple filter circuit. These approaches also help in that using a separate ADC/DAC unit tends to fix the precision of conversion, whereas the method discussed permits precision to be traded for sample speed under program control. Of course, this type of analog I/O is possible only with a fast enough processor that also has the predictable timing described in 2.2.2.

2.2.4 Coordination as a Parallel Computer

Each nanocontroller must coordinate to act as a single nanocontroller system. With thousands of sensors on a single chip, each with its own nanocontroller, it often is necessary to coordinate the actions of all the devices or to reduce thousands of sensor inputs to their single higher-level meaning. For example, a chip with a variety of types of analog sensors that are together able to detect or deduce levels of thousands of different chemical compounds might only need to report the action that the user should take to counter the set of chemical or biological agents currently sensed. Thus, the nanocontrollers must be able to act together as a parallel computing system. Acting together requires both a mechanism for synchronization and a communication network.

2.2.5 Each Nanocontroller Independently Programmable

Each nanocontroller must be fully programmable as an independent processor. Although nanocontrollers may need to work together, control and sensing algorithms often require different constants or even different code paths depending on the state of the device with which each nanocontroller interacts.

2.2.6. Reprogrammability

Nanocontroller programs must be able to be changed easily. The nanocontrollers may have their program upgraded or changed under various conditions. Similarly, as a control system rather than a general-purpose computer, it is likely that submission of a new program from outside the system will be infrequent.

2.3 Nanocontroller System Architecture

The primary architectural concern in nanocontroller design is minimization of circuit size. This issue has been a concern for the parallel supercomputing world with a desire to have many parallel processing elements as possible without exceeding the total system complexity budget. The SIMD (Single Instruction Multiple Data) model is the best fit.

2.3.1 SIMD (Single-Instruction Multiple-Data)



Figure 2.2: Block diagram of a SIMD system

The basic idea behind SIMD is to operate the same instruction sequence simultaneously on a large number of discrete data sets. SIMD targets machines that exhibit massive amounts of data parallelism without complicated control flow or excessive amounts of inter-processor communication.

SIMD consists of fine grained computational units called Processing Elements (PE). An array of PEs is connected together by a simple network topology. This processor array is connected to a control unit, which is responsible for fetching and interpreting instructions. The control unit issues arithmetic and data processing instructions to the array of processors, and handles any control flow or serial computation that cannot be parallelized. For flexibility in implementing algorithms, processing elements can usually be individually disabled for conditional execution. The instructions issued by the control processor are executed by the processor array in lockstep operation. Thus, control for a SIMD machine is vastly simplified, and synchronization issues can be avoided.

2.3.2 MIMD (Multiple Instructions Multiple Data)

Machines in MIMD systems are independently programmable and function asynchronously. Each processor may be executing different instructions on different data sets. MIMD has the independent programming feature that SIMD cannot provide. Each PE has to have instruction decode, addressing and sequencing logic. Replicating this additional logic per PE will increase the size of each nanocontroller.



Figure 2.3: Block diagram of MIMD system

The SIMD model on its own cannot support the independently programmable feature of the nanocontroller. The independent programmability feature of a MIMD machine can be emulated on a SIMD engine. MIMD emulation on SIMD is possible by a compiler technology that allows millions of independent programs to be merged into a single state machine while preserving relevant timing properties. This technology, called MSC (Meta-State Conversion), makes independent program memories unnecessary – nanocontroller circuit complexity is not proportional to program complexity. In combination with aggressive use of new compile-time optimization technologies (from gate-level logic optimization to a new genetic algorithm for code ordering and register allocation) and a very simple 1-bit datapath, digital nanocontrollers require at most a few hundred transistors.

2.3.3 Meta-State Conversion

In the nanocontrollers, the simplicity of SIMD processors and the independent programmability of MIMD processors are desired at the same time. While there are several techniques available for MIMD emulation on SIMD hardware ([2] [3] [4]), they all require that each PE must have a copy of the MIMD program in their local memory which adds a lot of hardware to a traditional SIMD processor.

Meta-State Conversion [5] is a compiler technique which considers the set of processor states at a particular time as a single meta-state. Using static scheduling techniques [6], MSC converts a MIMD program into a SIMD-executable finite automaton based on meta-states. The next meta-state is decided based on the global OR of votes from all participant processors. The generated meta-state automaton is held by the SIMD control unit, thereby removing the necessity of a separate instruction memory for each processing element.

2.3.4 CSI (Common Sub-Expression Induction)

After MSC, many meta-states in the meta-state graph contain more than one MIMD state. These MIMD states contain many instructions that in true MIMD execution would have been executed in parallel. Execution of these instructions on SIMD hardware serializes the instructions, with each PE enabled only for the MIMD code it would have executed. Nanocontrollers simulate disable of PEs by masking operations. Efficiency of execution can be improved by factoring the operations that are common between different MIMD states, which allow them to be executed in parallel by the SIMD PEs. Common Sub-expression Induction [7] is the technique which develops a code schedule for the SIMD PEs by factoring common operations between different threads in a meta-state.

2.3.5 KITE (Kentucky If Then Else)

The "*Kentucky If Then Else*" nanocontroller array is essentially a massivelyparallel bit-serial SIMD with very low per-nanocontroller circuit complexity despite incorporating a variety of special attributes that enable the system to meet all the constraints of a nanocontroller. KITE efficiently implements a MIMD programming model on simple SIMD hardware. There is only one instruction ITE (If Then Else) in the Kentucky architecture. The Kentucky Architecture differs from traditional SIMD in that it implements control by selection and not by decoding each instruction and implementing the control necessary to make the processing element implement each instruction.

The *BitC compiler* converts the control code in high level language into a metastate automaton. Each meta-state in the automaton is composed of ITE DAGs (Directed Acyclic Graph) representing the MIMD states composing that state and ends in k-way branches to k possible meta-states. The next meta-state to transition to, is determined using a Global OR (GOR) of votes from all participant processors. The KITE architecture consists of 3 components Control Unit, Instruction Sequencer and the Nanoprocessing Element. Each component and their architectural details are discussed in detail in Chapter 3.

2.4 Related Work

Attempts to integrate sensors and processing elements on the same chip started in the late 80's with LAPP (Linear Array Picture Processor). Second generation chip PASIC [8] (Processor, A/D-converter, Sensor Integrated Chip) consists of a 256 by 256 sensor array. Two hundred and fifty six 8-bit serial A/D converters and shift registers, 256 bit serial ALUs and 256x 128 RAM all on the same chip. Both chips target image processing applications. Both LAPP and PASIC are not single chip systems. They had off chip control logic. The processing elements had limited functionality. The PASIC proved the viability of a general purpose smart image sensor.

"SCAMP" [9] (SIMD Current mode Analog Matrix Processor) is a processor per pixel fine grained SIMD (Single instruction Multiple Data) architecture intended for image processing applications. The processing element is completely analog and is embedded with the sensor. The resulting system retains some of the advantages of analog signal processing, while being a fully programmable general purpose massively parallel processor array. The analog processing elements execute a software program, performing consecutive instructions issued by a digital controller, similar to the digital microprocessor. The SCAMP chip can execute many image processing algorithms in real time.

The SCAMP control unit [10] acts as an interface between the SCAMP chip and the host computer. The control unit consists of an Instruction Sequencer and a System Controller. Instruction sequencer controls program execution and provides an interface to transfer processed data from the SCAMP array to the host. The system controller is an 8bit microcontroller responsible for maintaining the communications interface, configuring analog hardware, controlling the SCAMP sequencer and providing additional control over the SCAMP chip. Unlike the SCAMP system, nanocontrollers have digital processing unit along with analog sensors making the nanocontroller more versatile and easily reprogrammable for other applications.

"A Defect Tolerant Self-organizing Nano-scale SIMD Architecture" also known as SOSA (self organizing SIMD structures) consists of millions of limited capability nodes with high defect rates to self-organize into a set of SIMD processing elements. SOSA has two types of control logic. Configuration logic used to configure a node and real time control logic used to decode and execute instructions. Using a familiar data parallel programming model SOSA architecture can execute a variety of programs. Details of the control logic have not been clearly outlined. This research runs parallel to the nanocontrollers digital controller with similar placement and timing issues.

Chapter 3

To execute a program on a nanocontroller system the user will have to construct and simulate the program in software on the host computer using BitC. Compiled code is stored in the controller memory (Flash memory, EEPROM, or SRAM). Controller initiates an initialization process required to identify each processing element. The control unit controls the program memory interface, instruction fetch and branch evaluation. Instruction sequencer is responsible for generating necessary signals for instruction execution. This chapter provides a detailed description of the control hierarchy required to control a nanocontroller system.

3.1 Processing Element Architecture

The abstract architecture of the Nanocontroller Processing Element (NPE) is shown in figure 3.1. As a SIMD like hardware system, there is no need for each nanocontroller to have its own program memory.



Figure 3.1. Abstarct architecture of the Processing Elements

A simple 1-of-2 multiplexor shown in Figure 3.1 directly implements masking and also is able to implement any logic function efficiently. The instruction set contains just a single instruction called SITE (Store-If-Then-Else). With only one type of instruction, there is no op-code field; thus, a SITE can be represented by a tuple of four numbers. A SITE tuple (1,2,3,4) would be equivalent to the *C* language assignment reg1=(reg2?reg3:reg4) where reg1, reg2, reg3, and reg4 are all single-bit registers.

3.2 Processing Element Implementation Architecture

Despite the extreme simplicity of the abstract architecture shown in Figure 3.1, there are many different nanocontroller processing element (NPE) implementation architectures that might be appropriate. Different implementation architectures vary in cycle count per instruction, circuit complexity, and structure at the gate level and below.



Figure 3.2: NPE implementation Architecture

For nearly all possible nanocontroller implementation architectures, the bulk of the circuit complexity lies in the register file. The decoder circuit complexity per NPE is not as high as it might appear, since a modest-sized group of NPEs can share a decoder.



Figure 3.3: NPE implementation Signal Timing Chart

Given this four-cycle constraint, a more efficient NPE implementation architecture is shown in Figure 3.2. Note that there is no multiplexor in the design. In fact, there is no hardware structure that corresponds to an ALU of any kind. In the abstract architecture of Figure 3.1, one of the two values held in the t (then) or e (else) staging registers is always ignored. Since i (If) value can be known before the values would be loaded into t or e, we can logically move the multiplexor to an earlier position in the circuit and can eliminate one register by only saving the value that is selected. The timing diagram in Figure 3.3 shows how the behavior is controlled through a four-cycle SITE execution.

3.3 Control Hierarchy

Just as a conventional SIMD system uses a Control Unit (CU) to control the program memory interface, fetch instructions, evaluate branch instructions, etc., nanocontrollers are dependent on Nanocontroller Control Unit (NCU) for this highest level functionality. However, whereas a traditional CU decodes each instruction and implements the controls necessary to make the processing elements implement each instruction, the NCU performs neither of these functions. Those lower level functions are delegated to sequencers that reside nearer to the nanocontrollers, both physically and in the logical level hierarchy.

The NCU shown in Figure 3.4 consists of a smart block prefetch unit, Branch evaluation unit and SITE buffer. The primary task of the NCU is to dispatch chunks of microcode to the sequencer at a sufficient rate to permit continuous operations of the NPEs. The NPEs are targeted to operate at 1.5 to 2 GHz speed, which is clearly much faster than the NCU could fetch instructions from conventional off-chip memory. However, the SITEs are controlled by sequencers that implement control within each SITE instruction and thus, they are able to be fed 24-bit SITE instructions at a slower clock rate, about 500 MHz. By fetching 240-bit blocks of SITEs, The NCU gains the ability to fetch yet another order of magnitude slower than it needs to feed SITEs to the sequencer. The result is that about a 50 MHz NCU clock should be sufficient to support NPEs running at a clock rate as high as 2 GHz. It had earlier been assumed that an instruction block compression scheme would be needed to achieve sufficient instruction



fetch rates in the NCU, but sufficient bandwidth is available without any compression.

Figure 3.4: Block Diagram showing Control Hierarchy

Optimized blocks of microcode are stored in the prefetch unit, which also operates at the 50 MHz NCU clock frequency. The NCU decides which sequence of prefetched microcode is to be executed next by the NPEs.

The prefetch register file has 16 registers (R0 to R15). The width of each register file is 240 bits (10 SITEs). Each block of 10 SITES is sequentially written to the register file, with register R0 getting filled first followed by register R1, etc. Once register R15 is written, the contents of register R0 are replaced by a new block of microcode. This sequential flow continues until interrupted by a Control SITE (CS). A jump or conditional jump control operation bypasses the sequential flow between prefetched blocks, allowing execution to proceed from any prefetch register.

Reading from the prefetch register file is done sequentially starting with register R0, much as write operations fill the unit. Read and write occur simultaneously. In case of a clash between write and read, read is given first priority –to maintain real time timing properties, NPEs cannot be stalled. The SITEs are scanned for a control SITE before being written to the SITE buffer.

3.4 Control Flow

The nanocontrollers as mentioned earlier are single instruction set architecture and ITES being the only instruction. Control flow is handled by interrupting the normal sequential flow of the SITEs in the prefetch register file by embedding a Control SITE (CS) along with the regular SITEs. The detection, evaluation and necessary control signals are handled in the Branch Evaluation Unit (BEU). The BEU consists of a modified 240 bit shift register that shifts 24 bits at a time and some simple logic decoders. The BEU decode logic identifies the type of control SITE and generates the appropriate control signals.

The control SITE (CS) is formatted much like an ordinary SITE, and is represented in 24 bits as shown in the figure. The control SITE is detected when there is 6'b000000 in the "S" (Save) position of the SITE. This encoding is possible because the NPE memory registers 0 and 1 are hardwired to have the values 0 and 1. Thus, it never makes sense to store into these two NPE memory registers, and a CS would act as a null operation if it were to be attempted by a NPE.



Figure 3.5: 204 bit microcode and Control SITE

The control instructions indicated by the bit fields [17:16] of the control SITE are:

1. Load register

 $00 \Rightarrow LD r$, offset

This control instruction needs memory access. Program counter is interrupted and with the help of offset, next block of code to be obtained is determined. The offset is 12 bits and can point to 4096 memory locations. The new microcode from memory is written to prefetch register file. The 4-bit register pointer from the CS will point to the register where the new microcode has to be written in the prefetch register file.

2. Jump register

 $01 \Rightarrow JMP r$ //offset bits are ignored

A simple jump operation in the prefetch register file interrupts sequential read operation. The register pointed by the CS will be read from prefetch register file.

3. Jump on global OR

$10 \Rightarrow$ JMP or r //offset bits are ignored

This instruction is serviced when global-OR bit goes high. The global-OR signal is the result of *OR-ing* together a one bit output from each NPE. Interestingly, the NPE clocks are not synchronized in order to create this output; instead the NPEs each make their contribution when their local clock sees fit, but the NCU sampling of the global-OR is scheduled sufficiently later so as to make the clock skew and OR propagation delay invisible. This scheduling is simply a matter of having enough SITEs between the setting and reading of global-OR; it is implemented entirely by compile-time scheduling of the SITEs. When the branch evaluation unit sees "10" op-code it stores the register pointer value. When the global-OR signal becomes 1, the sequencing switches to read from the register whose index was saved.

4. NOP

 $11 \Rightarrow NOP$

This code is used for future use.

Fetching of microcode, detection of CS and interrupt servicing takes place in the smart branch evaluation unit. The SITEs from the prefetch unit are not directly sent to the sequencer. They are stored in a buffer called SITE Buffer (SB). The SB consists of thirty 24 bit registers and works on the principle of FIFO (first in first out). The buffer is needed to increase the performance of the control unit. When the load interrupt is being serviced, a single cycle of prefetch delay is introduced. Normally we nullify this delay by making NPEs execute instructions that do not alter their states until valid new instructions arrive. By having a buffer of 30 SITEs we can perform a jump of 10 SITEs in the SB whenever a "Load" interrupt occurs.

3.5 Sequencer

The purpose of a sequencer shown in Figure 3.6 is to prevent a slow broadcast rate from slowing down the NPEs. The current design limits four NPEs per sequencer. By sharing the decode logic among more NPEs, The transistor count per NPE can be reduced

dramatically. However there is a classical engineer tradeoff. Clearly, 16-32 NPEs sharing a sequencer will reduce circuit complexity per NPE with negligible ill effects. Huge degree of sharing would require high fan-out, thus limiting the NPE clock rate.



Figure 3.6: Sequencer Block Diagram

As mentioned earlier the SITE must be executed over a sequence of four clock cycles. The sequencer generates four consecutive clock cycles worth of control information for the NPEs as If, Then, Else and Save sequence. The sequencer reads from the SB one SITE at a time. A mutated shift register circuit accepts the 24bit SITE and shifts 6 bits-position per cycle to specify the register number for the register file decoder. A state machine is used to generate the appropriate signals for the SITE execution. It is observed that simple four bit circular left shifter with initial inputs as "1001" can act as the state machine.

Each of the NPEs has a 64 bit register file called nanoprocessor memory (NPM). The NPM contains the bulk of the circuit complexity associated with the nanocontrollers. This again leads to engineering tradeoffs between sharing design logic and NPE operation speed. Registers 0 and 1 are hardwired to ground and Vcc respectively. With only a single bit datapath, 0 and 1 are the only constants possible, so any of the register sources in a SITE can essentially be a constant instead. Register 2 is hardwired to the input and register 3 is hardwired to the global-or input. Register 62 and register 63 are hardwired to the global-or out and output pin respectively. The global OR registers are used by control unit to manage conditional branching. The input and output pins are used for interconnection and initialization of NPEs.

3.6 Interconnection Network

The nanocontroller system has two types of interconnection network. Each processing element is connected to its neighbor in a ring network. The ring network has a special purpose of identifying individual processing elements. The second interconnection network is the Global-Or network and is used for control flow operations.

Four of the 64 NPM address locations in each NPE are used as ports on two separate networks. Two addresses interface the global-OR network that, provide the only mechanism for conditional control flow. The NPEs are not capable of directly altering the instruction sequence they will execute, but sending a value to the NCU via the global-OR network provides a traditional SIMD CU conditional branching mechanism based on "any" processing element wanting an alternative path taken. This mechanism is necessary in order to implement constructs such as SIMD "while" loops that can iterate for a dynamically determined number of iterations-which may be very rare in real-time control code, but is necessary in order to make the system capable of fully general computation. The global-OR signal also can be used as a bit-serial external output from the NPE array.

The other two addresses are used to connect the NPEs in a simple "wormhole routed" ring topology. Although one would expect this network to be intended primarily for communicating data between nearby NPEs, and it can be used that way, but is not its primary function. Fundamentally, in order for different NPEs to behave differently, each needs to have a notion of its identity. Parallel systems typically accomplish this by having a dedicated hardware register in each processor that holds "IPROC", the unique number identifying that processor within that system. However with a million NPEs storing IPROC would take 20 bits-nearly 1/3 of the entire address space available to each NPE. The ring network offers a better alternative.

Rather than dedicating multiple 1-bit registers, the ring network can be used to sequentially initialize the NPEs. The process is:

- Initially, all NPEs initialize a 20-bit counter to 0 and output a 0 to the next NPE. This takes 21 SITEs.
- 2. Repeat as many times as there are processors:
 - a. A 1 is generated by the NCU as a initial input to the ring.
 - b. Each processor copies its ring input to its ring output. If that input was 0, the NPE also increments its 20-bit counter. This software counter takes ~140 SITESs plus the additional time, if any needed to cover clock skew between neighboring NPEs.

For a million-NPE system, we would expect a total initialization time of about 1M x 140 x 4 clock cycles, or about half a second at a 1 GHz NPE clock. However this initialization only happens once, and from that time onwards it is not necessary that all 20 bits of IPROC values is maintained. The IPROC values can be used to create appropriate initial states and then be discarded.

Nanocontroller architecture features and functionality can be modeled using software emulation. An accurate timing analysis, device utilization and sensor integration can be tested using a hardware prototype. Full custom CMOS ASIC or high end FPGA can be used for hardware prototyping. Some of the advantages and disadvantages of both prototyping methods have been listed in the following section.

3.7 ASIC vs. FPGA

The advantages of full custom CMOS ASIC implementation are:

- Lower unit costs: For very high volume designs costs comes out to be very less.
 Larger volume of ASIC design proves to be cheaper than implementing design using FPGA.
- Speeds of ASICs are faster than FPGAs: ASICs provide more design flexibility. This gives enormous opportunity for speed optimizations.

- Low power: There are several low power techniques such as power gating, clock gating are available to achieve the power target.
- In ASIC you can implement analog circuit, mixed signal designs. This is generally not possible in FPGA.

The advantages of FPGA implementation are:

- Faster time-to-market: No layout, masks or other manufacturing steps are needed for FPGA design. Readymade FPGA is available to burn your HDL code to FPGA.
- No NRE (Non Recurring Expenses): This cost is typically associated with an ASIC design. For FPGA this is not there. FPGA tools are cheap, ASIC are expensive.
- Simpler design cycle: This is due to software that handles much of the routing, placement, and timing. Manual intervention is less. The FPGA design flow eliminates the complex and time-consuming floor planning, place and route, timing analysis.
- More predictable project cycle: The FPGA design flow eliminates potential respins, wafer capacities, etc of the project since the design logic is already synthesized and verified in FPGA device.
- Field Reprogramability: A new bit-stream can be uploaded remotely, instantly.
 FPGA can be reprogrammed in a snap while an ASIC can take \$50,000 and more than 4-6 weeks to make the same changes. FPGA costs start from a couple of dollars to several hundred or more depending on the hardware features.
- Reusability: Reusability of FPGA is its main advantage. Prototype of the design can be implemented on FPGA which could be verified for almost accurate results so that it can be implemented on an ASIC. If design has faults change the HDL code, generate bit stream, program to FPGA and test again. Modern FPGAs are reconfigurable both partially and dynamically.

ASIC chips can be embedded along with Analog sensors. FPGAs do not come with sensor elements as of now. Full custom ASIC provides a better hardware modal

for nanocontroller implementation. The initial cost of designing the proposed ASIC chip is several tens of thousands of dollars. Due to the low cost, ease of reprogramability and faster design time FPGA implementation has been opted. The next chapter provides the implementation details of nanocontrollers using a Xilinx FPGA chip.

Chapter 4

4.1 Virtual Prototyping and Validation

This chapter describes high level Design Entry, Synthesis, Implementation and Device programming of a nanocontroller system. The design has been described in Verilog, synthesized with Xilinx ISE 10.1 synthesis tool, simulated using Modelsim 6.4a and implemented on a Xilinx virtex-2xcv3000 FPGA. Before a hardware prototype was built, behavioral simulation has been done to validate the functionality and performance of the design. Design implementation followed by Functional simulation and Static Timing analysis was done for a complete design verification. The FPGA design flow is illustrated in the flow diagram shown in Figure 4.1.



Figure 4.1: FPGA Design flow

4.2 Design Entry

Modular and bottom up hierarchical design approaches have been employed during the design capture process. The modular design approach partitions the entire system into smaller modules or functional units that can be independently designed and described in Verilog. Besides, identical modules with the same functionalities can share the same Verilog code or reuse the previously designed module. In addition, the bottom up hierarchical design approach allows a multilevel view of the entire system for design ease. Hence, by employing these approaches the smaller modules or functional units can be tested and validated before they are integrated to form a larger system.



Figure 4.2: Organization of functional units within nanocontroller architecture

The Figure 4.2 shows the organization of functional units within the nanocontroller system. For simplicity the main modules are shown and other sub-modules within the main modules have been omitted. Behavioral, RTL (Register Transfer Level) and structural coding styles have been used during the design process. The advantage of behavioral coding is that only the behaviors of the modules are described in the code and the CAD software implicitly generates the internal logic blocks.

4.3 Functional Unit Description

4.3.1 Memory Controller:

This module oversees all the digital I/O operations, acting as an interface to the Block RAM (BRAM) and the prefetch unit. The memory controller runs at twice the

frequency of the global clock to increase the system speed and efficiency. The controller is a simple mealy state machine with 4 states as shown in the Figure 4.4. Memory controller operates in 3 modes namely Write, Read and simultaneous Read/Write.



Figure 4.3: Block diagram of memory controller



cir, mem and rw are the inputs to the state machine

Figure 4.4: State diagram of memory controller

Block RAM (BRAM) modules provided in the Virtex-2 chip store the program to be executed by the nanocontroller system. Block RAMs can be instantiated with help of a Verilog HDL template or by using the Block RAM IP cores provided by Xilinx [11]. The size of the block RAM instantiated is 120KB. The current design has a maximum capability of addressing 4096X240 bits. The size of the memory is restricted by the bits allocated for offset (12 bits) from section 3.4. There is provision for increasing the number of offset bits but a majority of the programs intended to run on a nanocontroller system require less than 120KB of memory.

4.3.2 Block RAM:

Xilinx provides configurable memory modules on the virtex-2 chip called BRAMs. BRAMs come in different sizes like RAMB4 (4KB) and RAMB16 (16KB) blocks. Multiple blocks can be combined to form a larger memory block. For the nanocontroller program memory, a 240 bits wide 4K addressable space block RAM is configured.

Data2MEM [12] tool is used to enter the compiled program code from the BitC complier to the BRAM blocks. Data2MEM is a data translation tool. It translates contiguous blocks of data across multiple Block RAMs (BRAMs) that constitute a contiguous logical address space. A BMM file (.bmm) defines the organization of Block RAM memory. MEM file (.mem) is used to define the contents of the defined BRAM.

4.3.3 Prefetch Unit:

The purpose and operation of prefetch unit is described in section 3.5. This module consists of a Register file, Read/Write Address pointers and a control unit controlling the contents of the prefetch units as shown in the figure.



Figure 4.5: Block diagram of prefetch unit

The Register file can read and write simultaneously as pointed by the Read/Write address pointers. Initially the prefetch unit is programmed to write 10 registers after which reading is enabled. When read and write pointers point to the same register then read operation is given first priority over write. Write to that register occurs on the next cycle.

4.3.4 Branch Evaluation Unit (BEU):



Figure 4.6: Block diagram of branch evaluation Unit

The BEU module receives 240 bits of microcode at a time from prefetch unit and broadcasts 24 bit SITEs to the sequencer array. 240 bit shifter shifts 24 bits (one SITE) at a time. The BEU unit operates on 2 clocks, an input clock running 10 times slower than an output clock. Each SITE is scanned for Control SITE before storing in the SITE Buffer. The SITE buffer is a FIFO (First In First Out) unit. Like the prefetch register file the SITE buffer can read and write simultaneously. Reading from this register file is enabled after 10 write operations.

4.3.5 Generic Sequencer Unit:

The sequencer consists of 4 NPEs sharing the same decode logic. The generic coding style enables the user to increment the NPE count in multiples of four. Each sequencer executes the SITE instruction in 4 clock cycles with the help of a controller that sends the appropriate control signals to the NPEs. The current design under test (DUT) contains 4 such SIMD blocks (16 NPEs).

Each sequencer unit along with 4 NPEs utilizes ~300 CLB (Configurable Logic Blocks). Major portion of these CLBs is taken up by NPE memory. This happens because Xilinx synthesis tool uses distributed RAM instead of block ram for NPE memory. Distributed RAM is made up of the LUT (look up tables) in CLBs.

4.3.5 Global-Or: The global-or module is a huge or-gate used for looping and iterative operations. This large or-gate is built as a network of smaller or-gates to reduce the fan out on each gate. MOD 10/MOD 4 counters are used to generate control signals. The Program Counter keeps track of the memory location to be read next from the main memory.

4.4 Behavioral Simulation

4.4.1 Testing Methodology:

The testing methodology employed in this project uses the bottom up approach. Lower level functional components such as nanoprocessing elements, sequencer, etc were tested before combining them to form higher level functional units. Bottom up approach in is an efficient testing approach. When the lower level components are combined into higher level functional units, one can be more assured that the lower level components will not be at fault if errors are detected.

4.4.2.1 Control hierarchy features

The nanocontroller has a few unique operations like initialization and control flow. This section demonstrates these featured operations by running a simple test program. The program has been written in a way that it exhibits all the above mentioned operations.

4.4.2.2 Initialization

As discussed in section 3.6, each nanocontroller has to be identified to behave as an independent processing element. To act independently each NPE has to be given a unique identification number. This is achieved by the "Iproc" instruction and takes approximately 140 SITEs per nanocontroller for a million NPE system. The number of SITEs required for initialization increases with the increase in number of NPEs. The test program takes lesser SITES as we have 16 NPEs in the current test module. All the NPEs initialize a 4 bit counter (registers 20 to 23) to 0. At the end of the initialization process the first NPE stores 0000 and the last NPE has 1111. This can be seen in the simulation shown in figure 4.7.

						A chartel I Trissennisennianiani ani ani
0000 11100	111	000	111	1111 000		/nano_4_dock/UUT/GSEQ0/SEQN/R0/RAM_amay(21) 0000
IIII		0000	ш	1		/nano_4_dock/UUT/IGSEQQI/SEQN/R0/RAM_array[22] 0000
•		Ē				/nano_4_dock/UUT/GSEQ0/SEQN/R0/RAM_amay[23] 0000
•				-	-	New Divider
•	010 101	0000				/nano_4_clock/UUT/GSEQ0/iloop[2]/SEQ/R0/RAM_array[20] 0000
•	1100	0000	111	000	•	/nano_4_dock/UUT/GSEQ0/iloop[2]/SEQ/R0/RVM_array[21] 0000
-		0000	11			<pre>/nano_4_dock/UUT/IGSEQ0/iloop[2]/SEQ/R0/R4M_array[22] 0000</pre>
	-	-				<pre>/nano_4_dodk/UUT/GSEQ0/iloop[2]/SEQ/R0/R4M_array[23] 0000</pre>
	-					New Divider
		1010	1110 0010			/nano_4_clock/UUT/GSEQ0/ilcop[1]/SEQ/R0/R4M_array[20] 0000
			110	000	-	/nano_4_dock/UUT/GSEQ0/iloop[1]/SEQ/R0/RAM_array[21] 0000
-			11			/nano_4_dock/UUT/GSEQ0/iloop[1]/SEQ/R0/RAM_array[22]
•					-	<pre>/nano_4_dock/UUT/GSEQ0/iloop[1]/SEQ/R0/R4M_amay[23] 0000</pre>
				1010 01010		/nano_4_dodd/UUTI/GSEQ0/SEQ0/R0/RAM_array[20] 0000
				1100		/nano_4_dock/UUT/GSEQ0/SEQ0/R0/R4M_array[21]
•						/nano_4_dock/UUT/GSEQ0/SEQ0/R0/R4M_array[22]
					-	/nano_4_occu/uu i/oseQu/seQu/Nu/NewTartay[23] uuuu

Figure 4.7: Initialization of Nanoprocessing Elements

The ability to identify NPEs facilitates independent programmability to the nanocontroller system.

4.4.2.3 Control Flow Handling

Control flow is handled by interrupting the normal sequential flow of SITEs in the prefetch register file. As discussed in section 3.4 there are 3 types of interrupts load, jump

and global-or. This section provides simulations to observe the operation of these interrupts.

The signals to observe:

Mem_addr_in_sig is the address pointer to the block RAM.

 C_{out_sig} is the feedback from the branch evaluation unit. The MSB 4 bits point to the register in prefetch unit to which the jump must occur and the last 12 bits point to offset. *branch*, ld_op_sig tell the control unit that a valid control SITE was detected. Branch signal goes high when a control site is detected. ld_op_sig indicate that a load interrupt has occurred.

M_out points to the register to be written in prefetch unit.

MARsr points to the register to be read in prefetch unit.

gout_sig is high when global or is set.



Figure 4.8: Load Instruction Simulation

When the control word detects a load operation, branch and ld_op_sig signals go high. 4 MSB bits of C_out_sig points to Register R13 and has an offset of 3. The prefetch register R13 is loaded with the contents of address location 3 from the memory.



Figure 4.9: Jump Instruction Simulation

The control word detects a jump operation the branch signal goes high and ld_op_sig signal stays low and 4 MSB bits of C_out_sig point to Register R14 and the offset is ignored. The prefetch unit outputs R14 instead of sequential R7.





Figure 4.10: Global or interrupt simulation

We know that the Register 62 of all nanocontrollers is hardwired to the global-or out pin. When RAM_array[62] of all the registers become high the global or bit is set as indicated by the gout_sig signal. C_out_sig points to register R0 of prefetch unit ignoring the offset.

4.5 Hardware prototype using iMPACT

After the nanocontroller architecture design is synthesized and implemented using CAD packages, a bit stream file (that contains proprietary header information as well as configuration data) for a specific FPGA chip is generated. In this case, the bit stream file contains the configuration bit file for the Xilinx XCV3000 FPGA chip. Next, the bit stream file is programmed into the FPGA through the parallel port of a computer using the Xilinx iMPACT [13], a file generation and device programming tool. iMPACT tool uses JTAG (Joint Test Action Group) ports to configure the devices and automatically identify the size and composition of the boundary scan chain. Any supported Xilinx device will be recognized and labeled in iMPACT.

As discussed in section 4.3.2 the program code is also configured along with the device in the block RAM module. A fully configured FPGA functionality is tested by observing its outputs with the help of a logic analyzer. An easier method for testing the

device functionality is by IEEE 1149.1 Standard Test Access Port and Boundary-Scan Architecture.

4.6 Testing Using JTAG

Xilinx XCV devices use a standard 4 wire Test Access Port (TAP) for In-System programming and Boundary scan (JTAG) testing. Boundary scan is a methodology allowing complete controllability and observability of boundary pins of a JTAG compatible device via software control. This capability enables in-circuit testing without the need of bed-of-nail in-circuit test equipment. The TAP controller is a state machine (16 possible states) controlling operations associated with boundary scan cells. The basic operation is controlled through four pins: Test Clock (TCK), Test Mode Select (TMS), Test Data In (TDI), and Test Data Out (TDO). The Xilinx boundary scan architecture is shown in figure 4.11.



Figure 4.11: JTAG Boundary scan architecture [14]

The Xilinx iMPACT automatically generates a Serial Vector Format (SVF) file describing the programming and test algorithms required by the XCV devices [14]. Most ATE platforms and Boundary Scan based development tools accept SVF as a test vector input format. By sending test vectors in the SVF file to the input boundary pins and observing the output boundary pins we can test the functionality of the DUT (Device Under Test).

Chapter 5

This chapter observes the performance of nanocontroller system. Minimum circuit size is the primary objective for a nanocontroller system. To compare the circuit utilization of the nanocontroller system we make use of its FPGA implementation described in chapter 4. The current implementation is compared with processor cores obtained from *opencores.org*. Device utilization, operating time and functional density parameters have been used for comparison. The scalability of nanocontrollers with logarithmically increasing NPEs is discussed along with the timing analysis.

5.1 Device Utilization

The primary objective of a nanocontroller system is to have minimum circuit complexity. The performance of nanocontrollers can be evaluated by comparing other processor systems designed using Verilog/VHDL and implemented on an FPGA. Processor cores used for comparison have been taken from opencores.org [15], [16], [17], [18]. All cores are FPGA proven and synthesized using Xilinx 10.1 ISE tool on a virtex-2 xcv3000 chip. The hardware utilization i.e. slices (CLBs) and 4 input LUTs have been tabulated as shown in the Table 1. The Maximum frequency data tabulated is obtained from the Post-synthesis delay (FF delay + data delay).

Processor		Device Utilization			
Architecture	Cores	Slices	4-input LUTs	Max. MHz	Density
OpenRISC	1×32-bit	7,115	14,009	69.04	0.0097
M1	1×32-bit	2,744	4,666	89.38	0.0325
16-bit Microcontroller	1×16-bit	1,014	1,938	86.28	0.0424
T-48 / MCS-48	1×8-bit	771	787	30.00	0.00972
Nanocontroller (cores)	32×1-bit	2,546	3,175	185.37	0.0728

Table 1: Devive Utilization of processing element architectures

Functional Density = (Throughput ÷ Area) in Mbps/CLB

Area-measured in CLB - Configurable Logic Block Throughput - number of bits processed per second

Figure 5.1: Functional Density metric

Functional *Density* metric [19] is used to compare the performance of processor cores. Functional density is a composite area-time metric used to identify the computational throughput (operations per second) of unit hardware resources. Functional Density depends on the Area measured in the FPGA "cell count" and operating time which is the optimal "cycle time" of the mapped FPGA circuit.

A Normalized Cost/Performance for different processing element architectures graph is shown in figure 5.2. 16-bit Microcontroller and T-48 cores have lower device utilization (slices and LUTs) but their clock period and Area/throughput go up when compared to the nanocontroller. Nanocontroller system exhibits the highest functional density among the compared cores.



Figure 5.2: Normalized Cost/Performance of Processing Element Architectures

5.2 Scalability of Nanocontrollers

Scalability of nanocontrollers can be observed from the device utilization, maximum frequency and Functional Density data from the table 2. The nanocontroller system was implemented by logarithmically increasing the number of processing elements to the maximum possible on the virtex-2 chip.

Nanocontroller	Device	Utilization, inclu	ding Control I	lierarchy
Cores	Slices	4-input LUTs	Max. MHz	Density
16×1-bit	1,892	2,731	181.56	0.0479
32×1-bit	3,052	3,600	181.56	0.0594
64×1-bit	5,366	7,155	181.54	0.0676
128×1-bit	9,988	13,024	181.47	0.0718
256×1-bit	19,120	25,225	181.26	0.0758

Table 2: Device utilization scaling for nanocontroller system

The numbers of slices and LUTs, and functional density, scale better than linearly due to the fact that the control hierarchy contribution increases logarithmically. In fact, the analysis using 256 NPEs finds a slightly better density than the analysis presented earlier (in Table 1) found for 32 NPEs without including the complexity of the memory and I/O unit at the top of the control hierarchy. This is most likely due to minor changes in the way the design is fit into the FPGA, but certainly indicates that scaling to large numbers of NPEs is not likely to imply a drop in density.



Figure 5.3: Performance of nanocontroller system with increasing NPEs

SIMD machines traditionally have low clock rates restricted by the broadcast delays to all the PEs run at the same clock in a lock step manner. The nanocontrollers use a hierarchical clock system to overcome the broadcast delay. This can be observed

from the Maximum frequency numbers from table 2. The maximum clock speeds do suffer a reduction as the number of nanoprocessors is increased, but the reduction going from 16 to 256 cores is less than 0.2%. Even this small reduction in clock speed is likely an artifact of routing issues within the FPGA implementation. A custom chip implementation is not expected to suffer this much reduction in clock rate as the number of cores are increased.

5.3 Timing analysis

Timing analysis helps in verifying that the design meets the timing constraints of the nanocontroller architecture. Timing simulation uses the timing and design layout information that is available after place and route to give a more accurate assessment of the behavior of the circuit under worst-case conditions. This enables simulation of the design to closely match the actual device operation.

The clock frequency of a digital circuit is heavily dependent on circuit delay (hold time and setup time). To calculate the delay associated with the hierarchical clock mechanism of the nanocontroller we start by determining the delay associated with the smallest clock. The Post-Route simulation takes into account all the delays associated with the circuit. The delay associated with all the clocks has been and tabulated as shown in Table 3.

Clock	Heirarchical		
Level	Clock Scale Factor	Delay	Max. MHz
Memory and I/O	1x	16.773	59.62
Sequencer	10×	12.316	81.20
Nanoprocessor	40×	9.940	100.60

Table 3: Post Place and Route Timing analysis

The timing analysis was performed using the Xilinx Timing Analyzer tool. The clock cycle delay data provided is the Post-Place and route delay which includes 7 types of delays (Clock to setup + Clock to pad + Clock pad to output pad + pad to pad + Pad to Setup + Setup to Clock at Pad + paths ending at clock pin of flip flops).

Connection of all signals to I/O pads has a leveling effect on the delays, so that the changes in clock rate at the different control levels are smaller than they would be in a

custom-made chip. The post-synthesis delay of nanocontrollers is 5.6008ns The PEs are connected to I/O pins which is introducing 4.34ns additional delay making the total delay 9.94ns.

Total delay is the sum of logic delay and route delay. For a sequencer clock: Total delay= (1.089ns logic, 11.176ns route) =12.316ns. It is to be noted that delay of a circuit implementation in an FPGA is mostly due to routing delay (91.1% route delay). A full custom CMOS ASIC implementation will have much less routing delay and higher operating frequency.

Chapter 6

6.1 Conclusion

Using existing CMOS fabrication technology an array of programmable controllers can be fabricated on a single chip with all controllers coordinating as one massively parallel computer. A control unit is an essential part of nanocontroller system responsible for instruction execution and program memory interface.

The current thesis provided details of control hierarchy required for a nanocontroller system. To validate the design, a complete Verilog description along with an FPGA prototype has been presented. Hardware constraints associated with nanocontroller system like minimal circuit complexity, predictable real time behavior, coordination as a parallel computer, digital I/O, reprogramability and independently programmable NPEs have been addressed.

6.2 Future work

Current thesis provides digital control to a nanocontroller system. ADC (analog to digital converters) and pulse width modulation (PWM) circuit along with analog sensors complete the system. Integration of analog circuit and digital system will be the next step in building a nanocontroller array. The current FPGA implementation can be tested with the help of a bidirectional LED array, [20] simple control system in which the ambient light is sensed by LEDs (reversed biased) is read by the NPEs with the help of ADC. The input from ADC is stored in memory. The sensed data can be manipulated and sent to the LED array in emitter (forward biased) mode. The system can be tested with other sensors like temperature, capacitive, CCD etc.

Although an FPGA implementation helps understand the performance, timing constraints and functionality of a nanocontroller system, inherently nanocontrollers have to be embedded alongside nanotechnology devices. Such a system can only be achieved with a full custom CMOS ASIC implementation. MOSIS (a low cost prototyping and small volume production service for VLSI development) prototype will provide the most accurate model for a nanocontroller system.

As the number of NPEs approach a million the size of the die increases introducing clock skew. Clock skew is a phenomenon that occurs in synchronous circuits in which the clock signal arrives at different components at different times. In a SIMD system clock skew is a major concern as the system works in a lock step mechanism. The clock skew associated broadcast of SITEs to the sequencer limits the number of processing elements. The current FPGA implementation due to the restriction in the number of processing elements could not model the effects of clock skew in a nanocontroller system. This has to be addressed in the future implementations.

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Vita

Author's Name: Akshay Vummannagari Birthplace: Hyderabad, India Birthdate : April 25, 1984 Education: Bachelor of Engineeering in Electrical Engineering Osmania University May-2006. Research Experience: University of Kentucky Lexington, KY Graduate Research Assistant (12/08 - 8/09).